

ATTORNEY DOCKET NO.: AGX-14-CPA-RCE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IIV THE ONITED OF THE	
In re Application of: Gat, et al.) Group Art Unit: 2881
Serial No.: 09/226,396) Examiner: Nguyen, Kiet Tuan
Filed: January 6, 1999) Our Account No.: 04-1403
Confirmation No.: 1125) Customer ID: 22827
Title: Heating Semiconductor Wafers In Thermal Processing Chambers))
SUBMISSION OF FORMAL DRAWINGS AND ISSUE FEE	
MAIL STOP ISSUE FEE Commissioner For Patents P. O. Box 1450 Alexandria, VA 22313-1450	
Sir:	
Respectfully submitted for filing is our enclosed check for the issue fee, publication fee	
and advanced copies along with six (6) pages of corrected formal drawings for the above-	
identified patent.	
	Respectfully submitted,
BY: Dated:	DOR/TY & MANNING, P.A. Vimothy A. Cassidy Reg. No. 38,024 P. O. Box 1449 Greenville, SC 29602-1449 (864) 271-1592
I hereby certify that this correspondence is being deposited with the United States Postal	(864) 233-7342 (Fax)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents, U. S. Patent and Trademark Office, MAIL STOP ISSUE FEE, P. O. Box 1450 Alexandria, VA 22313-1450 on

June 14, 2004
Panula Knon

Pamela Knorr